



NOTES :

1. MATERIAL

- i) HOUSING : HIGH TEMPERATURE THERMOPLASTIC UL94V-0
- ii) TERMINAL : COPPER ALLOY
- iii) HOLD DOWN : COPPER ALLOY

2. FINISH

- i) TERMINAL : Au PLATING AT CONTACT POINT
MATT TIN PLATING 100u" MIN AT SOLDER TAIL WITH NICKEL 50u" MIN UNDERPLATE.
- ii) HOLD DOWN : MATT TIN PLATING.
MATT TIN PLATING 100u" MIN AT SOLDER TAIL WITH NICKEL 50u" MIN UNDERPLATE.
- 3. THE HOUSING WILL WITHSTAND EXPOSURE TO 260 DEGREE C PEAK TEMPERATURE FOR 10 SECONDS IN A CONVECTION, INFREA RED, OR VAPOR PHASE REFLOW OVEN.
- 4. Packaging spec. GS-14-840.
- 5. Product Spec. GS-12-194.
- 6. Product Spec. 110-634

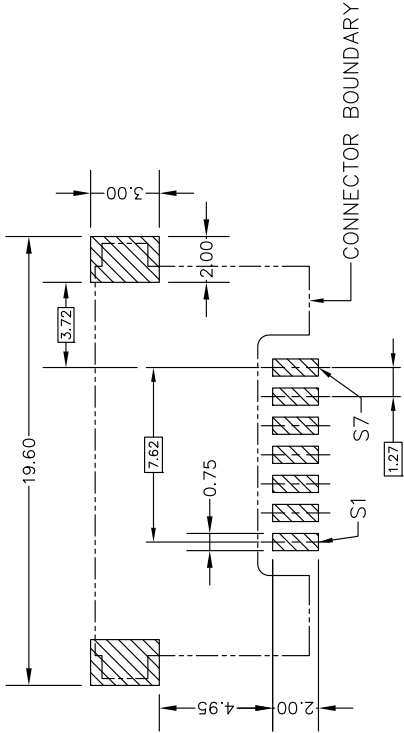
10089036- 0 X X X LEAD FREE

BLANK: SPEC AS NOTE 5
J: SPEC AS NOTE 6

- 1: G/F PLATING AT CONTACT
- 2: 15U" GOLD AT CONTACT
- 3: 30U" GOLD AT CONTACT

0: TAPE & REEL PACKING WITH PICK UP CAP

Δ1: TAPE & REEL PACKING WITHOUT PICK UP CAP



RECOMMENDED MOUNTING LAYOUT
RECOMMENDED PCB T: 1.6mm
TOLERANCE UNLESS OTHERWISE ±0.1mm

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ltr	ecn no	dr	date	linear	angles			projection	title	www.fciconnect.com
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